

RoHS Compliant Product
A suffix of "-C" specifies halogen & lead-free

FEATURES

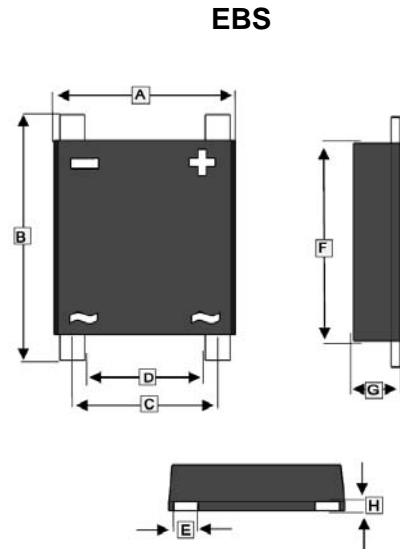
- Ideal for printed circuit board
- Lead tin plated copper
- Reliable low cost construction utilizing molded plastic technique results in inexpensive product

MECHANICAL DATA

- Polarity: Symbol molded on body
- Mounting position :Any

PACKAGE INFORMATION

| Package | MPQ | Leader Size |
|---------|-----|-------------|
| EBS | 5K | 13 inch |



| REF. | Millimeter | | REF. | Millimeter | |
|------|------------|------|------|------------|------|
| | Min. | Max. | | Min. | Max. |
| A | 4.9 | 5.1 | E | 0.6 | 0.7 |
| B | 6.0 | 6.4 | F | 5.3 | 5.5 |
| C | 3.9 | 4.1 | G | 1.15 | 1.27 |
| D | 3.2 | 3.5 | H | 0.15 | 0.25 |

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Rating 25°C ambient temperature unless otherwise specified. Single phase half wave, 60Hz, resistive or inductive load.
For capacitive load, de-rate current by 20%.)

| Parameter | Symbol | Part Number | | | | | | | Unit |
|--|-------------------------|-------------|---------|---------|---------|---------|---------|---------|-----------------------------|
| | | EBS 101 | EBS 102 | EBS 103 | EBS 104 | EBS 105 | EBS 106 | EBS 107 | |
| Maximum Recurrent Peak Reverse Voltage | V_{RRM} | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum RMS Bridge Input Voltage | V_{RMS} | 35 | 70 | 140 | 280 | 420 | 560 | 700 | V |
| Maximum DC Blocking Voltage | V_{DC} | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum Average Forward Rectified Output | I_F | 1 | | | | | | | A |
| Peak Forward Surge Current 8.3 ms Single Half Sine-Wave Super Imposed on Rated Load (JEDEC Method) | I_{FSM} | 30 | | | | | | | A |
| Maximum Forward Voltage @ 1A | V_F | 1.1 | | | | | | | V |
| Maximum DC Reverse Current at Rated DC Blocking Voltage | $T_J=25^\circ\text{C}$ | 5 | | | | | | | μA |
| | $T_J=100^\circ\text{C}$ | 200 | | | | | | | |
| Typical Thermal resistance junction to case ¹ | $R_{\theta JC}$ | 20 | | | | | | | $^\circ\text{C} / \text{W}$ |
| Typical Thermal resistance junction to Lead ¹ | $R_{\theta JL}$ | 22 | | | | | | | $^\circ\text{C} / \text{W}$ |
| Typical Thermal resistance junction to Ambient ¹ | $R_{\theta JA}$ | 42 | | | | | | | $^\circ\text{C} / \text{W}$ |
| Operating and Storage temperature range | T_J, T_{STG} | -55~150 | | | | | | | $^\circ\text{C}$ |

Note:

1. Thermal Resistance test performed in accordance with JESD-51. Unit mounted on Aluminum substrate _ 15 x 15 x 1.6mm.

RATINGS AND CHARACTERISTIC CURVES

FIG. 1-TYPICAL FORWARD CURRENT DERATING CURVE

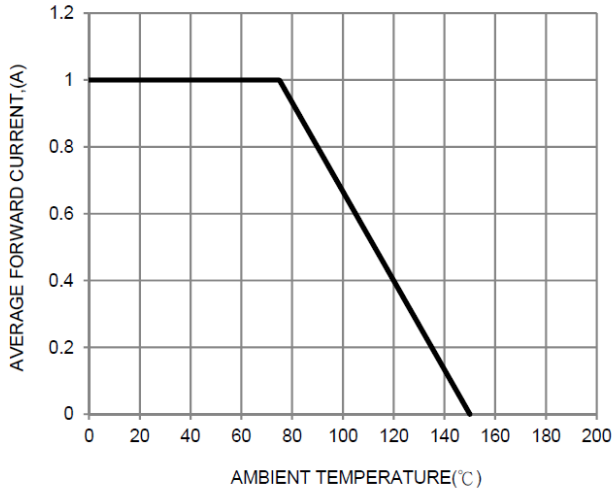


FIG. 2-TYPICAL FORWARD CHARACTERISTICS

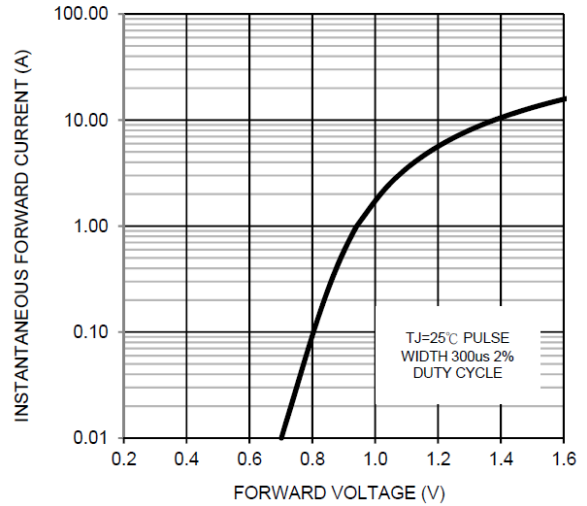


FIG. 3-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

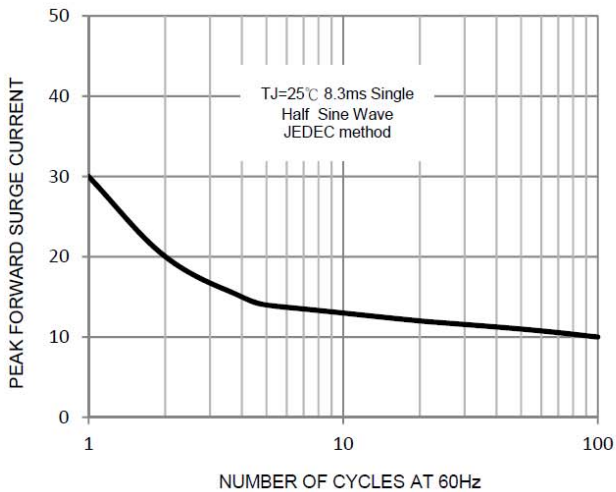


FIG. 4-TYPICAL REVERSE CHARACTERISTICS

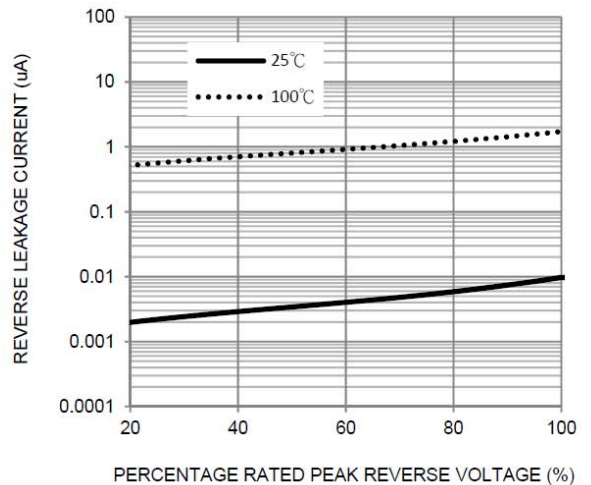


FIG. 5-TYPICAL JUNCTION CAPACITANCE

